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TOSHIBA Photocoupler Photorelay

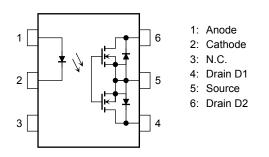
TLP3105

Measurement Equipment FA (Factory Automation) Power Line Control Security Equipment

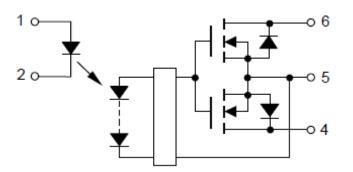
The Toshiba TLP3105 consists of an aluminum gallium arsenide infrared emitting diode optically coupled to a photo-MOSFET in a SOP, which is suitable for surface-mount assembly. The TLP3105 features high ON-state current and low ON-state resistance, hence the TLP3105 is suitable to control a power line.

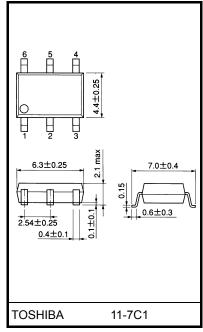
- 6-pin SOP (2.54SOP6): 2.1 mm high, 2.54 mm pitch
- Normally opened (form A) device
- Peak OFF-state voltage: 100 V (min)
- Trigger LED current: 3 mA (max)
- ON-state current: 1.4 A (max) (Ta=50°C)
- ON-state resistance: 0.1Ω (typ.), 0.2Ω (max)
- Capacitance: 1000 pF (typ.)
- OFF-state current: 10 nA (max)
- Isolation voltage: 1500 V_{rms} (min)

Pin Configuration (top view)



Schematic





Weight: 0.13 g (typ.)

Unit: mm

Absolute Maximum Ratings (Ta = 25°C)

| Characteristics | | | Symbol | Rating | Unit |
|-----------------------------------|---|--------------|----------------------|------------|-------|
| LED | Forward current | | ١ _F | 30 | mA |
| | Forward current derating (Ta \ge 25°C) | | ∆l _F /°C | -0.3 | mA/°C |
| | Reverse voltage | | V _R | 5 | V |
| | Junction temperature | | Tj | 125 | °C |
| | Off-state output terminal voltage | | VOFF | 100 | V |
| | On-state current | A connection | | 1.4 | |
| | | B connection | ION | 1.4 | А |
| | | C connection | | 2.8 | |
| Detector | Forward current derating (Ta ≥ 50°C) | A connection | | -18.7 | |
| | | B connection | ∆l _{ON} /°C | -18.7 | mA/°C |
| | | C connection | | -37.3 | |
| | Pulse on-state current(t = 100ms) | | I _{ONP} | 4 | A |
| | Junction temperature | | Tj | 125 | °C |
| Storage temperature | | | T _{stg} | -55 to 125 | °C |
| Operating | Operating temperature | | T _{opr} | -40 to 85 | °C |
| Lead soldering temperature (10 s) | | | T _{sol} | 260 | °C |
| Isolation | Isolation voltage (AC, 1 min, R.H. \leq 60%) (Note 1) | | | 1500 | Vrms |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

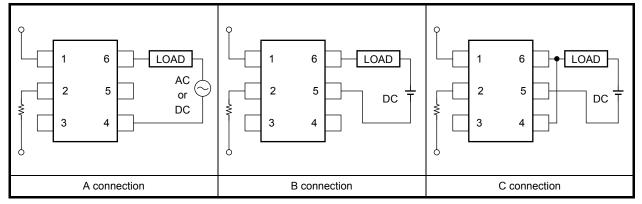
Note 1: Device considered a two-terminal device: Pins 1, 2 and, 3 shorted together, and pins 4, 5 and 6 shorted together.

Recommended Operating Conditions

| Characteristics | Symbol | Min | Тур. | Max | Unit |
|-----------------------|------------------|-----|------|-----|------|
| Supply voltage | V _{DD} | _ | _ | 100 | V |
| Forward current | ١ _F | _ | 7.5 | 20 | mA |
| Operating temperature | T _{opr} | -20 | | 65 | °C |

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Circuit Connections



Individual Electrical Characteristics (Ta = 25°C)

| | Characteristics | | Test Condition | Min | Тур. | Max | Unit |
|----------|-------------------|------------------|--------------------------|------|------|------|------|
| | Forward voltage | VF | I _F = 10 mA | 1.18 | 1.33 | 1.48 | V |
| LED | Reverse current | I _R | $V_R = 5 V$ | _ | _ | 10 | μA |
| | Capacitance | CT | V = 0, f = 1 MHz | _ | 70 | _ | pF |
| ector | OFF-state current | IOFF | V _{OFF} = 100 V | | _ | 10 | nA |
| Detector | Capacitance | C _{OFF} | V = 0, f = 1 MHz | | 1000 | | pF |

Coupled Electrical Characteristics (Ta = 25°C)

| Characteristics | | Symbol | Test Condition | Min | Тур. | Max | Unit |
|---------------------|--------------|-----------------|---|-----|-------|-----|------|
| Trigger LED current | | I _{FT} | I _{ON} = 100 mA | _ | _ | 3 | mA |
| Return LED current | | I _{FC} | I _{OFF} = 10 μA | 0.1 | _ | _ | mA |
| | A connection | R _{ON} | I _{ON} = 1.4 A, I _F = 5 mA, t<1s | _ | 0.1 | 0.2 | |
| On-state resistance | B connection | | I _{ON} = 1.4 A, I _F = 5 mA, t<1s | _ | 0.05 | 0.1 | Ω |
| | C connection | | $I_{ON} = 2.8 \text{ A}, I_F = 5 \text{ mA}, t < 1 \text{ s}$ | _ | 0.025 | | |

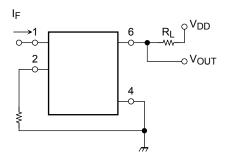
Isolation Characteristics (Ta = 25°C)

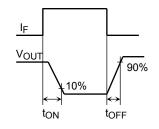
| Characteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|-----------------------------|----------------|--|-------------------|------------------|-----|-------|
| Capacitance input to output | CS | $V_S = 0 V$, f = 1 MHz | _ | 0.8 | _ | pF |
| Isolation resistance | R _S | $V_S = 500 \text{ V}, \text{ R.H.} \le 60\%$ | 5×10^{10} | 10 ¹⁴ | _ | Ω |
| | | AC, 1 min | 1500 | | | Vrms |
| Isolation voltage | - | AC, 1 s (in oil) | _ | 3000 | | viins |
| | | DC, 1 min (in oil) | | 3000 | _ | Vdc |

Switching Characteristics (Ta = 25°C)

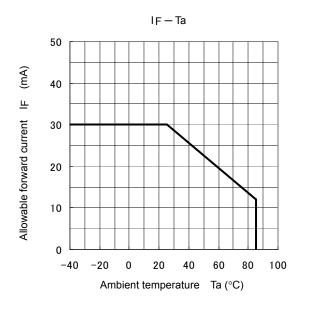
| Characteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|-----------------|-----------------|--|-----|------|-----|------|
| Turn-ON time | ton | $R_L = 200 \ \Omega$ | — | 1.0 | 5.0 | |
| Turn-OFF time | tOFF | $V_{DD} = 20 \text{ V}, \text{ I}_{\text{F}} = 5 \text{ mA}$ (Note 2 |) — | 0.15 | 1.0 | ms |
| Turn-ON time | t _{ON} | R _L = 200 Ω | — | 0.5 | 3.0 | 1115 |
| Turn-OFF time | tOFF | $V_{DD} = 20 \text{ V}, I_F = 10 \text{ mA}$ (Note 2 |) — | 0.15 | 1.0 | |

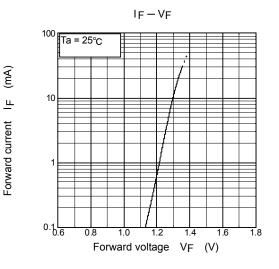
Note 2: Switching time test circuit

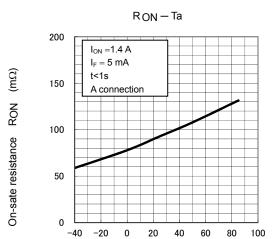


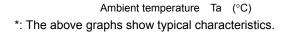


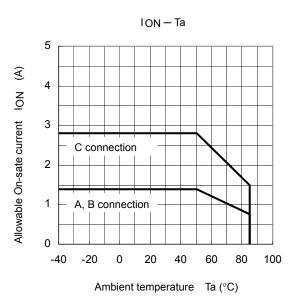
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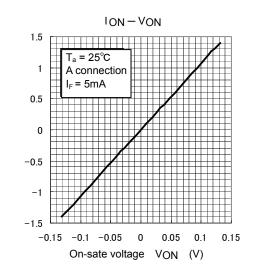




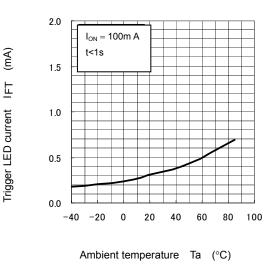










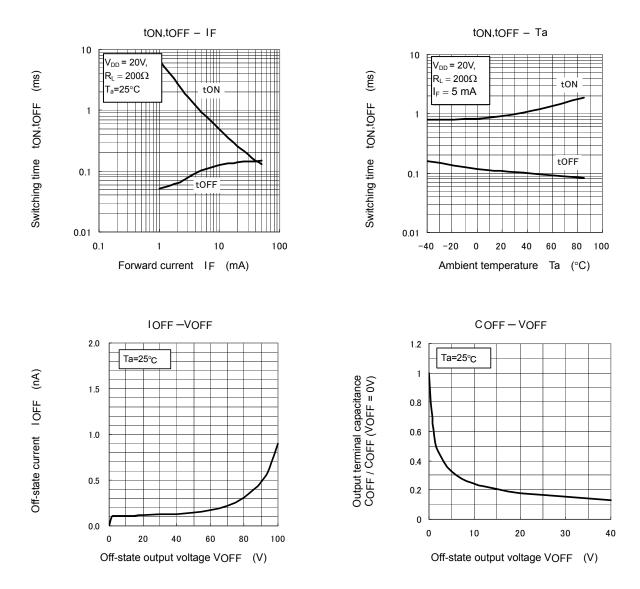


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On-sate current ION

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*: The above graphs show typical characteristics.

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